

# **SN74AXC4T774 Evaluation Module User Guide**

---



---



---

This user's guide describes the characteristics, operation, and use of the SN74AXC4T774EVM Evaluation Module (EVM). A complete printed-circuit board layout, schematic diagrams, and bill of materials are included in this document.

## **Contents**

1	Introduction .....	2
2	Board Layout .....	4
3	Schematic and Bill of Materials .....	5

## **List of Figures**

1	SPI/JTAG Translation using SN74AXC4T774EVM .....	3
2	SN74AXC4T774EVM Layout .....	4
3	SN74AXC4T774EVM RSV Schematic.....	5
4	SN74AXC4T774EVM PW Schematic .....	5

## **List of Tables**

1	SN74AXC4T774 Functional Table(Each 1-bit section) .....	2
2	SPI, JTAG Interface EVM setup .....	2
3	SN74AXC4T774EVM Bill of Materials .....	6

## **Trademarks**

All trademarks are the property of their respective owners.

## 1 Introduction

The AXC devices are a new family of direction controlled level translators from Texas Instruments. AXC devices have dual-supply pins enabling configurable voltage translation between 0.65 V and 3.6 V and any intermediate voltage ranges. The SN74AXC4T774EVM can be used to evaluate [SN74AXC4T774](#) translator device in the PW or the RSV packages. Refer to the competitive advantages of the AXC Family in the application report *Power sequencing for the AXC family of devices (SCEA058)*. Watch [Introduction to the AXC family of direction controlled translation device](#).

### 1.1 Features

The AXC family of direction controlled translation devices are dual-supply with configurable voltage translation and an operating range from 0.65 V to 3.6 V. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 0.65 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 0.65 V to 3.60 V. The SN74AXC4T774 device is fully specified for partial-power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the outputs, thus preventing damaging current backflow through the device when the device is powered down. The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at ground, both A and B data I/O ports are in the high-impedance state.

The eight channel [SN74AXC8T245](#) device has two direction control pins, each controlling 4 data I/Os enabling independent and simultaneous up and down translation. Refer to [SN74AXC8T245EVM](#) for testing SN74AXC8T245PW package.

The four channel [SN74AXC4T774](#) device has individual direction control pins for each of its IO(A and B) ports to allow configurable up and down translation.

The functional table of the [SN74AXC4T774](#) is listed in [Table 1](#). This EVM is pre-configured to support translation for Serial Peripheral Interface (SPI) and Joint Test Action Group (JTAG) interface as shown in [Table 2](#). Refer to the low voltage translation for standard interfaces in the application report *Low voltage translation for SPI, UART, RGMII, and JTAG interfaces(SCEA065)*.

**Table 1. SN74AXC4T774 Functional Table(Each 1-bit section)**

OE	DIRx	Signal Direction
H	X	Hi-Z
L	L	B data to A bus
L	H	A data to B bus

**Table 2. SPI, JTAG Interface EVM setup**

PINS	PULL-UP (PW AND RSV)	PULL-DOWN (PW AND RSV)	DEFAULT STATE	STATUS
$\overline{OE}$	R1, R6	R13, R14	10k $\Omega$ to GND	DEVICE ENABLED
DIR1	R2, R7	NO	10k $\Omega$ to Vcca	A1(Input) TO B1(Output)
DIR2	R3, R8	NO	10k $\Omega$ to Vcca	A2(Input) TO B2(Output)
DIR3	R4, R9	NO	10k $\Omega$ to Vcca	A3(Input) TO B3(Output)
DIR4	R5, R10	R15, R16	10k $\Omega$ to GND	B4(Input) TO A4(Output)



## 2 Board Layout

Figure 2 illustrates the SN74AXC4T774EVM layout.

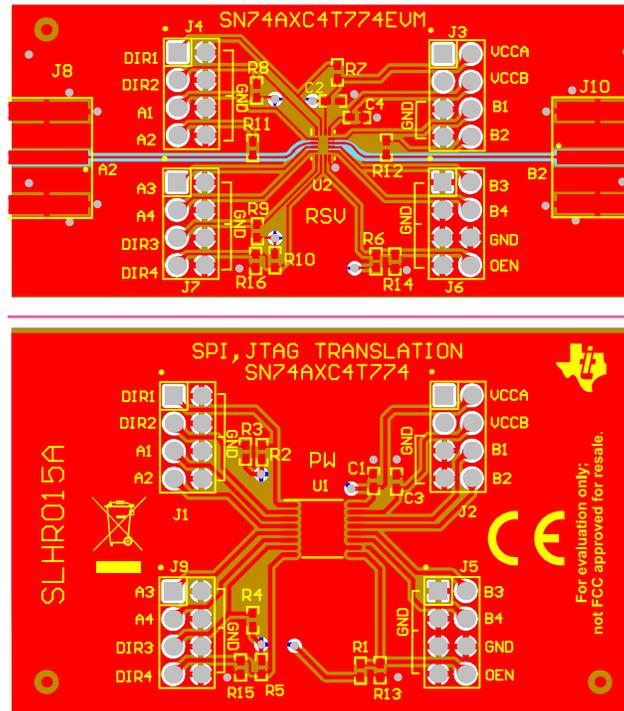


Figure 2. SN74AXC4T774EVM Layout

### 3 Schematic and Bill of Materials

#### 3.1 Schematic

Figure 3 and Figure 4 illustrates the SN74AXC4T774EVM schematic.

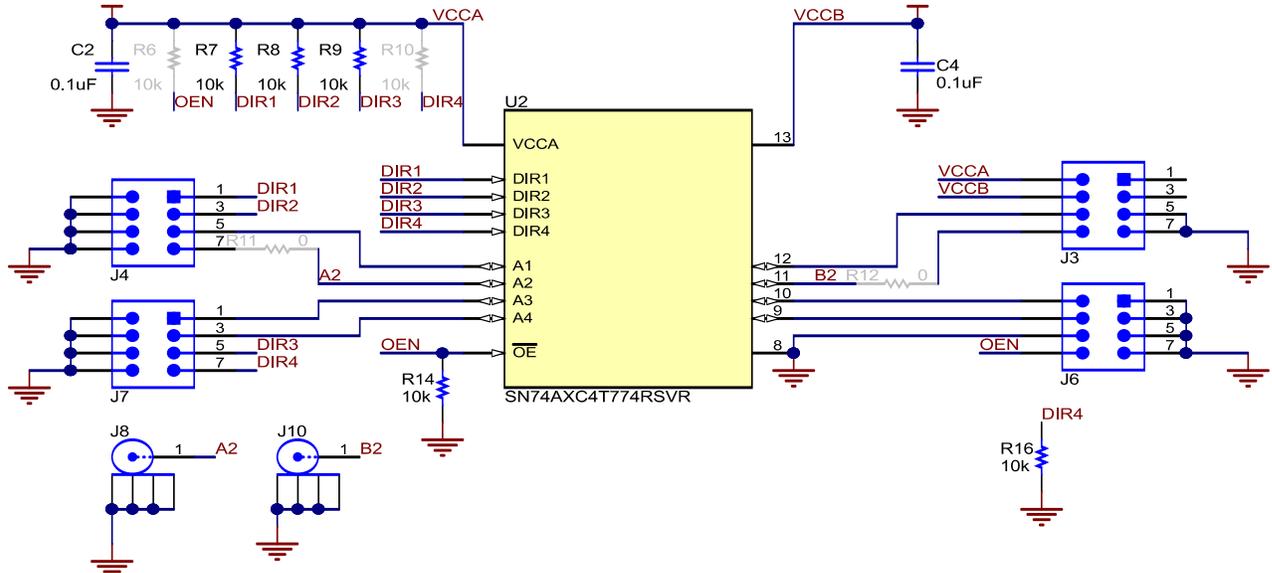


Figure 3. SN74AXC4T774EVM RSV Schematic

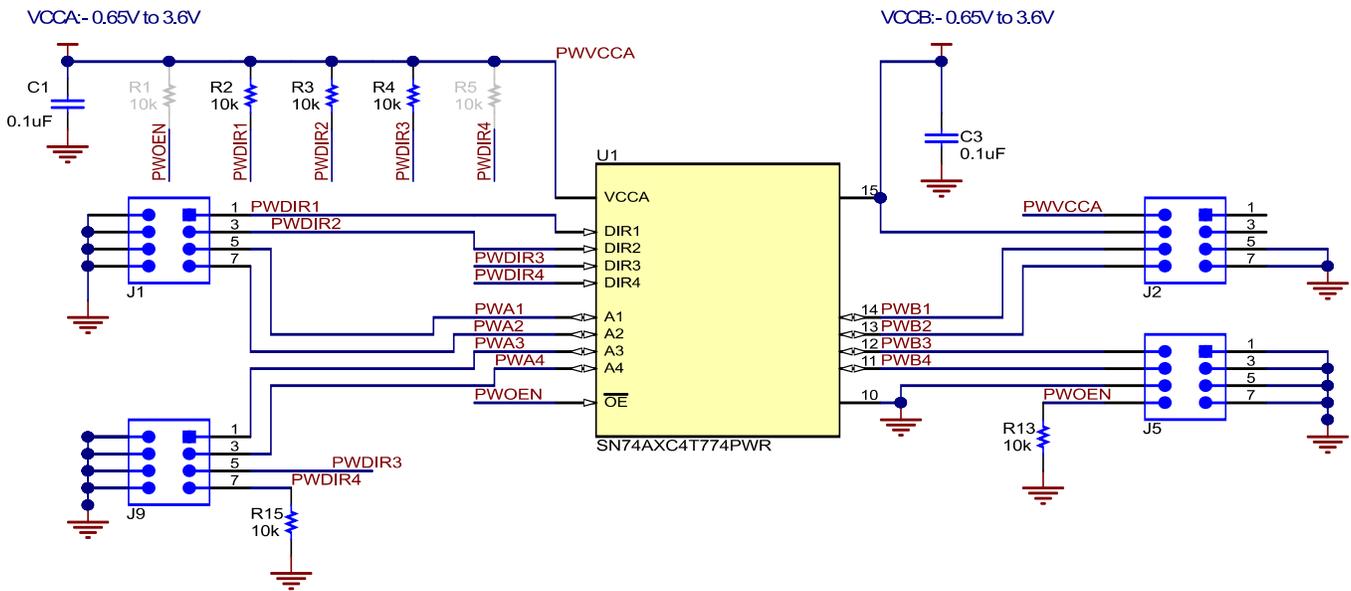


Figure 4. SN74AXC4T774EVM PW Schematic

### 3.2 Bill of Materials

Table 3 lists the SN74AXC4T774EVM bill of materials.

**Table 3. SN74AXC4T774EVM Bill of Materials**

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
C1, C2, C3, C4	4	0.1uF	CAP, CERM, 0.1 uF, 16 V, +/- 10%, X7R, 0402	0402	0402YC104KAT2A	AVX
J1, J2, J3, J4, J5, J6, J7, J9	8		Header, 100mil, 4x2, Gold, TH	4x2 Header	TSW-104-07-G-D	Samtec
J8, J10	2		Connector, SMB Jack, End launch, SMT	SMB End launch Jack, SMT	131-3701-801	Cinch Connectivity
R2, R3, R4, R7, R8, R9, R13, R14, R15, R16	10	10k	RES, 10 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	CRCW040210K0JNED	Vishay-Dale
U1	1		4 Bit Direction Controlled Level Translator, PW0016A (TSSOP-16)	PW0016A	SN74AXC4T774PWR	Texas Instruments
U2	1		4 Bit Direction Controlled Level Translator, RSV0016A (UQFN-16)	RSV0016A	SN74AXC4T774RSVR	Texas Instruments
FID1, FID2, FID3	0		Fiducial mark. There is nothing to buy or mount.	N/A	N/A	N/A
R1, R5, R6, R10	0	10k	RES, 10 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	CRCW040210K0JNED	Vishay-Dale
R11, R12	0	0	RES, 0, 5%, 0.063 W, 0402	0402	ERJ-2GE0R00X	Panasonic

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale ([www.ti.com/legal/termsofsale.html](http://www.ti.com/legal/termsofsale.html)) or other applicable terms available either on [ti.com](http://ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2019, Texas Instruments Incorporated